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Understanding [Embedded - FPGAs \(Field Programmable Gate Array\)](#)

Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

Applications of Embedded - FPGAs

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications.

Details

Product Status	Obsolete
Number of LABs/CLBs	10000
Number of Logic Elements/Cells	40000
Total RAM Bits	4075520
Number of I/O	604
Number of Gates	-
Voltage - Supply	0.95V ~ 1.26V
Mounting Type	Surface Mount
Operating Temperature	-40°C ~ 105°C (TJ)
Package / Case	1152-BCBGA, FCBGA
Supplier Device Package	1152-CFCBGA (35x35)
Purchase URL	https://www.e-xfl.com/product-detail/lattice-semiconductor/lfscm3ga40ep1-5fc1152i

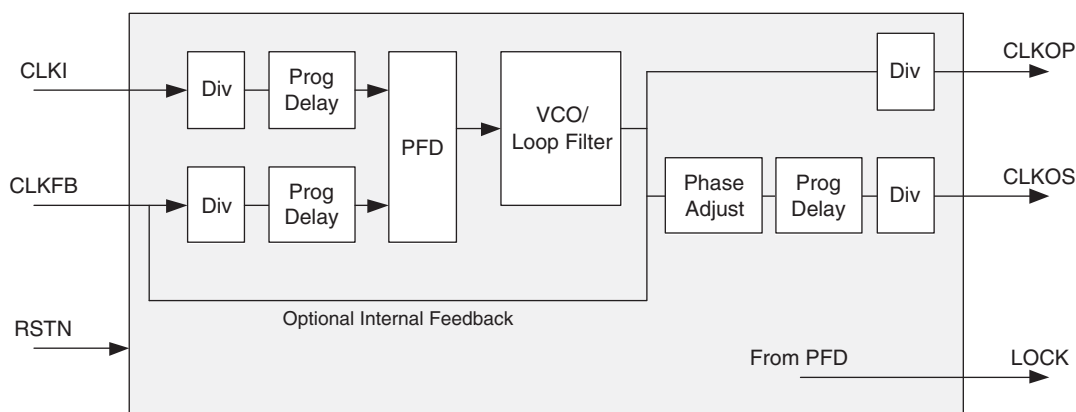
The setup and hold times of the device can be improved by programming a delay in the feedback or input path of the PLL which will advance or delay the output clock with reference to the input clock. This delay can be either programmed during configuration or can be adjusted dynamically.

The Phase Select block can modify the phase of the clock signal if desired. The Spread Spectrum block supports the modulation of the PLL output frequency. This reduces the peak energy in the fundamental and its harmonics providing for lower EMI (Electro Magnetic Interference).

The sysCLOCK PLL can be configured at power-up and then, if desired, reconfigured dynamically through the serial memory interface bus which connects with the on-chip system bus. For example, the user can select inputs, loop filters, divider setting, delay settings and phase shift settings. The user can also directly access the SMI bus through the routing.

The PLL clock input, from pin or routing, feeds into an input divider. There are four sources of feedback signal to the feedback divider: from the clock net, directly from the voltage controlled oscillator (VCO) output, from the routing or from an external pin. The signal from the input clock divider and the feedback divider are passed through the programmable delay before entering the phase frequency detector (PFD) unit. The output of this PFD is used to control the voltage controlled oscillator. There is a PLL_LOCK signal to indicate that VCO has locked on to the input clock signal. Figure 2-11 shows the sysCLOCK PLL diagram.

Figure 2-11. PLL Diagram



For more information on the PLL, please see details of additional technical documentation at the end of this data sheet.

Spread Spectrum Clocking (SSC)

The PLL supports spread spectrum clocking to reduce peak EMI by using “down-spread” modulation. The spread spectrum operation will vary the output frequency (at 30KHz to 500KHz) in a range that is between its nominal value, down to a frequency that is a programmable 1%, 2%, or 3% lower than normal.

Digital Locked Loop (DLLs)

In addition to PLLs, the LatticeSC devices have up to 12 DLLs per device. DLLs assist in the management of clocks and strobes. DLLs are well suited to applications where the clock may be stopped or transferring jitter from input to output is important, for example forward clocked interfaces. PLLs are good for applications requiring the lowest output jitter or jitter filtering. All DLL outputs are routed as primary/edge clock sources.

The DLL has two independent clock outputs, CLKOP and CLKOS. These outputs can individually select one of the outputs from the tapped delay line. The CLKOS has optional fine phase shift and divider blocks to allow this output to be further modified, if required. The fine phase shift block allows the CLKOS output to be phase shifted a further 45, 22.5 or 11.25 degrees relative to its normal position. LOCK output signal is asserted when the DLL is locked. The ALU HOLD signal setting allows users to freeze the DLL at its current delay setting.

Table 2-5. sysMEM Block Configurations

Memory Mode	Configurations
Single Port	16,384 x 1 8,192 x 2 4,096 x 4 2,048 x 9 1,024 x 18 512 x 36
True Dual Port	16,384 x 1 8,192 x 2 4,096 x 4 2,048 x 9 1,024 x 18
Pseudo Dual Port	16,384 x 1 8,192 x 2 4,096 x 4 2,048 x 9 1,024 x 18 512 x 36
FIFO	16,384 x 1 8,192 x 2 4,096 x 4 2,048 x 9 1,024 x 18 512 x 36

Bus Size Matching

All of the multi-port memory modes support different widths on each of the ports. The RAM bits are mapped LSB word 0 to MSB word 0, LSB word 1 to MSB word 1 and so on. Although the word size and number of words for each port varies, this mapping scheme applies to each port.

RAM Initialization and ROM Operation

If desired, the contents of the RAM can be pre-loaded during device configuration. By preloading the RAM block during the chip configuration cycle and disabling the write controls, the sysMEM block can also be utilized as a ROM.

Single, Dual and Pseudo-Dual Port Modes

In all the sysMEM RAM modes the input data and address for the ports are registered at the input of the memory array. The output data of the memory is optionally registered at the output. A clock is required even in asynchronous read mode.

The EBR memory supports two forms of write behavior for dual port operation:

1. **Normal** — data on the output appears only during a read cycle. During a write cycle, the data (at the current address) does not appear on the output.
2. **Write Through** — a copy of the input data appears at the output of the same port.

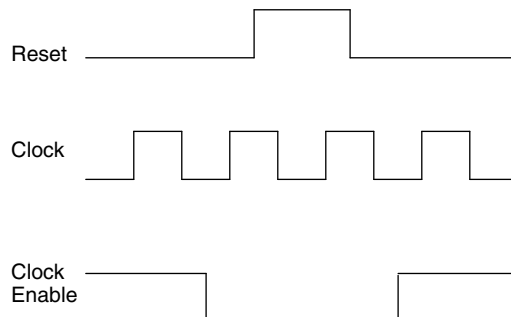
FIFO Configuration

The FIFO has a write port with Data-in, WCE, WE and WCLK signals. There is a separate read port with Data-out, RCE, RE and RCLK signals. The FIFO internally generates Almost Full, Full, Almost Empty, and Empty Flags. The Full and Almost Full flags are registered with WCLK. The Empty and Almost Empty flags are registered with RCLK.

EBR Asynchronous Reset

EBR asynchronous reset or GSR (if used) can only be applied if all clock enables are low for a clock cycle before the reset is applied and released a clock cycle after the low-to-high transition of the reset, as shown in Figure 2-16.

Figure 2-16. EBR Asynchronous Reset (Including GSR) Timing Diagram



If all clock enables remain enabled, the EBR asynchronous reset or GSR may only be applied and released after the EBR read and write clock inputs are in a steady state condition for a minimum of $1/f_{MAX}$ (EBR clock). The reset release must adhere to the EBR synchronous reset setup time before the next active read or write clock edge.

If an EBR is pre-loaded during configuration, the GSR input must be disabled or the release of the GSR during device Wake Up must occur before the release of the device I/Os becoming active.

These instructions apply to all EBR RAM, ROM, FIFO and shift register implementations. For the EBR FIFO mode, the GSR signal is always enabled and the WE and RE signals act like the clock enable signals in Figure 2-16. The reset timing rules apply to the RPRreset input vs. the RE input and the RST input vs. the WE and RE inputs. Both RST and RPRreset are always asynchronous EBR inputs. For the EBR shift register mode, the GSR signal is always enabled and the local RESET pin is always asynchronous.

Note that there are no reset restrictions if the EBR synchronous reset is used and the EBR GSR input is disabled. For more information about on-chip memory, see TN1094, [On-Chip Memory Usage Guide for LatticeSC Devices](#).

Programmable I/O Cells (PIC)

Each PIC contains four PIOs connected to their respective PURESPEED I/O Buffer which are then connected to the PADs as shown in Figure 2-17. The PIO Block supplies the output data (DO) and the Tri-state control signal (TO) to PURESPEED I/O buffer, and receives input (DI) from the buffer. The PIO contains advanced capabilities to allow the support of speeds up to 2Gbps. These include dedicated shift and DDR logic and adaptive input logic. The dedicated resources simplify the design of robust interfaces.

Initialization and Standby Supply Current

The table below indicates initialization and standby supply current while operating at 85°C junction temperature (T_J), which is the high end of the commercial temperature range, and 105°C, which is the high end of the industrial temperature range. This data assumes all outputs are tri-stated and all inputs are configured as LVCMOS and held at V_{CCIO} or GND. The remaining SERDES supply current for V_{DDIB} and V_{DDOB} is detailed in the SERDES section of this data sheet. For power at your design temperature, it is recommended to use the Power Calculator tool which is accessible in ispLEVER or can be used as a standalone tool. For more information on supply current, see the reference to additional technical documentation available at the end of this data sheet.

Over Recommended Operating Conditions

Symbol	Condition	Parameter	Device	25°C Typ. ¹	85°C Max. ²		105°C Max. ²	Units
				All	-5, -6	-7	-5, -6	
I_{CC}	(VCC = 1.2V +/- 5%)	Core Operating Power Supply Current	LFSC/M15	65	449	678	755	mA
			LFSC/M25	113	798	1255	1343	mA
			LFSC/M40	159	1178	2006	1981	mA
			LFSC/M80	276	2122	3827	3569	mA
			LFSC/M115	454	3376	—	5679	mA
	(VCC = 1.0V +/- 5%)	Core Operating Power Supply Current	LFSC/M15	45	312	471	524	mA
			LFSC/M25	79	554	872	933	mA
			LFSC/M40	110	818	1393	1375	mA
			LFSC/M80	191	1473	2658	2478	mA
			LFSC/M115	315	2344	—	3943	mA
I_{CC12}		1.2V Power Supply Current for Configuration Logic, FPGA PLL, SERDES PLL and SERDES Analog Supplies	LFSC/M15	23	39	59	35	mA
			LFSC/M25	25	50	78	56	mA
			LFSC/M40	31	78	133	89	mA
			LFSC/M80	50	108	195	123	mA
			LFSC/M115	65	131	—	154	mA
I_{CCAUX}		Auxiliary Operating Power Supply Current	LFSC/M15	7	12	19	14	mA
			LFSC/M25	9	16	25	18	mA
			LFSC/M40	12	23	39	25	mA
			LFSC/M80	13	25	45	23	mA
			LFSC/M115	16	27	—	26	mA
I_{CCIO} and I_{CCJ}		Bank Power Supply Current (per bank)	LFSC/M15	0.1	0.2	0.3	0.2	mA
			LFSC/M25	0.3	0.6	1.0	0.7	mA
			LFSC/M40	0.4	0.9	1.5	1.0	mA
			LFSC/M80	0.5	1.1	2.1	1.3	mA
			LFSC/M115	0.7	1.5	—	1.8	mA

1. I_{CC} is specified at $T_J = 25^\circ\text{C}$ and typical V_{CC} .

2. I_{CC} is specified at the respective commercial and industrial maximum T_J and V_{CC} limits.

PURESPEED I/O Recommended Operating Conditions

Standard	V _{CCIO} (V)			V _{REF} (V)		
	Min.	Typ.	Max.	Min.	Typ.	Max.
LVC MOS 33	3.135	3.3	3.465	—	—	—
LVC MOS 25	2.375	2.5	2.625	—	—	—
LVC MOS 18	1.71	1.8	1.89	—	—	—
LVC MOS 15	1.425	1.5	1.575	—	—	—
LVC MOS 12	1.14	1.2	1.26	—	—	—
LV TTL	3.135	3.3	3.465	—	—	—
PCI33	3.135	3.3	3.465	—	—	—
PCIX33	3.135	3.3	3.465	—	—	—
PCIX15	1.425	1.5	1.575	0.49V _{CCIO}	0.5V _{CCIO}	0.51V _{CCIO}
AGP1X33	3.135	3.3	3.465	—	—	—
AGP2X33	3.135	3.3	3.465	0.39V _{CCIO}	0.4V _{CCIO}	0.41V _{CCIO}
SSTL18_I, II ³	1.71	1.8	1.89	0.833	0.9	0.969
SSTL25_I, II ³	2.375	2.5	2.625	1.15	1.25	1.35
SSTL33_I, II ³	3.135	3.3	3.465	1.3	1.5	1.7
HSTL15_I, II ³	1.425	1.5	1.575	0.68	0.75	0.9
HSTL15_III ^{1,3} and IV ^{1,3}	1.425	1.5	1.575	0.68	0.9	0.9
HSTL 18_I ³ , II ³	1.71	1.8	1.89	0.816	0.9	1.08
HSTL 18_III ^{1,3} , IV ^{1,3}	1.71	1.8	1.89	0.816	1.08	1.08
GTL12 ^{1,3} , GTLPLUS15 ^{1,3}	—	—	—	0.882	1.0	1.122
LVDS	—	—	—	—	—	—
Mini-LVDS	—	—	—	—	—	—
RSDS	—	—	—	—	—	—
LVPECL33 (outputs) ²	3.135	3.3	3.465	—	—	—
LVPECL33 (inputs) ^{2,4}	—	≤ 2.5	—	—	—	—
BLVDS25 ^{2,3}	2.375	2.5	2.625	—	—	—
MLVDS25 ^{2,3}	2.375	2.5	2.625	—	—	—
SSTL18D_I ³ , II ³	1.71	1.8	1.89	—	—	—
SSTL25D_I ³ , II ³	2.375	2.5	2.625	—	—	—
SSTL33D_I ³ , II ³	3.135	3.3	3.465	—	—	—
HSTL15D_I ³ , II ³	1.425	1.5	1.575	—	—	—
HSTL18D_I ³ , II ³	1.71	1.8	1.89	—	—	—

1. Input only.

2. Inputs on chip. Outputs are implemented with the addition of external resistors.

3. Input for this standard does not depend on the value of V_{CCIO}.

4. Inputs for this standard cannot be in 3.3V VCCIO banks (≤ 2.5V only).

Signal Descriptions (Cont.)

Signal Name	I/O	Description
MPI_STRBN	I	Driven active low indicates the start of a transaction on the PowerPC bus. MPI will strobe the address bus at next rising edge of clock.
MPI_ADDR[31:14]	I	Address bus driven by a PowerPC bus master. Only 18-bit width is needed. It has to be the least significant bit of the PowerPC 32-bit address A[31:14].
MPI_DAT[n:0]	I/O	Selectable data bus width from 8, and 16-bit. Driven by a bus master in a write transaction. Driven by MPI in a read transaction.
MPI_PAR[m:0]	I/O	Selectable parity bus width from 1, 2, and 3-bit. MPI_DP[0] for MPI_D[7:0], MPI_DP[1] for MPI_D[15:8] and MPI_DP[2] for MPI_D[23:16].
MPI_TA	O	Transfer acknowledge. Driven active low indicates that MPI received the data on the write cycle or returned data on the read cycle.
MPI_TEA	O	Transfer Error Acknowledge. Driven active low indicates that MPI detects a bus error on the internal system bus for current transaction.
MPI_RETRY	O	Active low MPI Retry requests the MPC860 to relinquish the bus and retry the cycle.
Multi-chip Alignment (User I/O if not used.)		
MCA_DONE_OUT	O	Multi-chip alignment done output (to second MCA chip)
MCA_DONE_IN	I	Multi-chip alignment done input (from second MCA chip)
MCA_CLK_P[1:2]_OUT	O	Multi-chip alignment clock [1:2] output (sourced by MCA master chip)
MCA_CLK_P[1:2]_IN	I	Multi-chip alignment clock [1:2] input (from MCA master chip)
TEMP	—	Temperature sensing diode pin. Dedicated pin. Accuracy is typically +/- 10°C.
Miscellaneous Dedicated Pins		
XRES	—	External reference resistor between this pin and ground. The reference resistor is used to calibrate the programmable terminating resistors used in the I/Os. Dedicated pin. Value: 1K ± 1% ohm.
DIFFRx	—	Only used if a differential driver is used in a bank. This DIFFRx must be connected to ground via an external 1K ±1% ohm resistor for all banks that have a differential driver.
SERDES Block (Dedicated Pins)		
[A:D]_HDINPx_[L/R]	I	High-speed input (positive) channel x on left [L] or right [R] side of device. PCS quad is defined in the dual function name column of the Logic Signal Connection table.
[A:D]_HDINNx_[L/R]	I	High-speed input (negative) channel x on left [L] or right [R] side of device. PCS quad is defined in the dual function name column of the Logic Signal Connection table.
[A:D]_HDOuTPx_[L/R]	O	High-speed output (positive) channel x on left [L] or right [R] side of device. PCS quad is defined in the dual function name column of the Logic Signal Connection table.
[A:D]_HDOuTNx_[L/R]	O	High-speed output (negative) channel x on left [L] or right [R] side of device. PCS quad is defined in the dual function name column of the Logic Signal Connection table.
[A:D]_REFCLKP_[L/R]	I	Ref clock input (positive), aux channel on left [L] or right [R] side of device.
[A:D]_REFCLKN_[L/R]	I	Ref clock input (negative), aux channel on left [L] or right [R] side of device.

LFSC/M15, LFSC/M25 Logic Signal Connections: 900 fpBGA^{1, 2} (Cont.)

Ball Number	LFSC/M15			LFSC/M25		
	Ball Function	VCCIO Bank	Dual Function	Ball Function	VCCIO Bank	Dual Function
F19	PT37D	1	WRN/MPI_WR_N	PT46D	1	WRN/MPI_WR_N
F18	PT37C	1	D7/MPI_DATA7	PT46C	1	D7/MPI_DATA7
C18	PT37B	1	D6/MPI_DATA6	PT46B	1	D6/MPI_DATA6
C17	PT37A	1	D5/MPI_DATA5	PT46A	1	D5/MPI_DATA5
E17	PT36D	1	D4/MPI_DATA4	PT45D	1	D4/MPI_DATA4
E16	PT36C	1	D3/MPI_DATA3	PT45C	1	D3/MPI_DATA3
G18	PT35B	1	D2/MPI_DATA2	PT45B	1	D2/MPI_DATA2
G17	PT35A	1	D1/MPI_DATA1	PT45A	1	D1/MPI_DATA1
B18	PT33B	1	D0/MPI_DATA0	PT43B	1	D0/MPI_DATA0
B17	PT33A	1	QOUT/CEON	PT43A	1	QOUT/CEON
G16	PT32D	1	VREF2_1	PT42D	1	VREF2_1
A18	PT32B	1	DOUT	PT42B	1	DOUT
A17	PT32A	1	MCA_DONE_IN	PT42A	1	MCA_DONE_IN
H18	PT31B	1	MCA_CLK_P1_OUT	PT41B	1	MCA_CLK_P1_OUT
H17	PT31A	1	MCA_CLK_P1_IN	PT41A	1	MCA_CLK_P1_IN
D17	PT29B	1	MCA_CLK_P2_OUT	PT39B	1	MCA_CLK_P2_OUT
D16	PT29A	1	MCA_CLK_P2_IN	PT39A	1	MCA_CLK_P2_IN
F17	PT28D	1	MCA_DONE_OUT	PT38D	1	MCA_DONE_OUT
F16	PT28C	1	BUSYN/RCLK/SCK	PT38C	1	BUSYN/RCLK/SCK
C16	PT28B	1	DP0/MPI_PAR0	PT38B	1	DP0/MPI_PAR0
C15	PT28A	1	MPI_TA	PT38A	1	MPI_TA
B16	PT27B	1	PCLKC1_0	PT37B	1	PCLKC1_0
B15	PT27A	1	PCLKT1_0/MPI_CLK	PT37A	1	PCLKT1_0/MPI_CLK
H16	PT25D	1	DP3/PCLKC1_4/MPI_PAR3	PT35D	1	DP3/PCLKC1_4/MPI_PAR3
A16	PT25B	1	MPI_RETRY	PT35B	1	MPI_RETRY
A15	PT25A	1	A0/MPI_ADDR14	PT35A	1	A0/MPI_ADDR14
G15	PT24D	1	A1/MPI_ADDR15	PT33D	1	A1/MPI_ADDR15
F15	PT24C	1	A2/MPI_ADDR16	PT33C	1	A2/MPI_ADDR16
E15	PT24B	1	A3/MPI_ADDR17	PT33B	1	A3/MPI_ADDR17
D15	PT24A	1	A4/MPI_ADDR18	PT33A	1	A4/MPI_ADDR18
C14	PT23B	1	A5/MPI_ADDR19	PT32B	1	A5/MPI_ADDR19
C13	PT23A	1	A6/MPI_ADDR20	PT32A	1	A6/MPI_ADDR20
H14	PT21C	1	VREF1_1	PT31C	1	VREF1_1
B14	PT21B	1	A7/MPI_ADDR21	PT31B	1	A7/MPI_ADDR21
B13	PT21A	1	A8/MPI_ADDR22	PT31A	1	A8/MPI_ADDR22
G14	PT20B	1	A9/MPI_ADDR23	PT29B	1	A9/MPI_ADDR23
F14	PT20A	1	A10/MPI_ADDR24	PT29A	1	A10/MPI_ADDR24
A14	PT19B	1	A11/MPI_ADDR25	PT28B	1	A11/MPI_ADDR25
A13	PT19A	1	A12/MPI_ADDR26	PT28A	1	A12/MPI_ADDR26
G13	PT17D	1	D11/MPI_DATA11	PT27D	1	D11/MPI_DATA11
H13	PT17C	1	D12/MPI_DATA12	PT27C	1	D12/MPI_DATA12
E14	PT17B	1	A13/MPI_ADDR27	PT27B	1	A13/MPI_ADDR27
E13	PT17A	1	A14/MPI_ADDR28	PT27A	1	A14/MPI_ADDR28
G12	PT15D	1	A16/MPI_ADDR30	PT25D	1	A16/MPI_ADDR30
G11	PT15C	1	D13/MPI_DATA13	PT25C	1	D13/MPI_DATA13

LFSC/M15, LFSC/M25 Logic Signal Connections: 900 fpBGA^{1, 2} (Cont.)

Ball Number	LFSC/M15			LFSC/M25		
	Ball Function	VCCIO Bank	Dual Function	Ball Function	VCCIO Bank	Dual Function
N17	GND	-		GND	-	
N18	GND	-		GND	-	
N19	GND	-		GND	-	
N20	GND	-		GND	-	
P11	GND	-		GND	-	
P12	GND	-		GND	-	
P13	GND	-		GND	-	
P14	GND	-		GND	-	
P15	GND	-		GND	-	
P16	GND	-		GND	-	
P17	GND	-		GND	-	
P18	GND	-		GND	-	
P19	GND	-		GND	-	
P20	GND	-		GND	-	
R10	GND	-		GND	-	
R11	GND	-		GND	-	
R12	GND	-		GND	-	
R13	GND	-		GND	-	
R14	GND	-		GND	-	
R15	GND	-		GND	-	
R16	GND	-		GND	-	
R17	GND	-		GND	-	
R18	GND	-		GND	-	
R19	GND	-		GND	-	
R20	GND	-		GND	-	
R21	GND	-		GND	-	
T10	GND	-		GND	-	
T11	GND	-		GND	-	
T12	GND	-		GND	-	
T13	GND	-		GND	-	
T14	GND	-		GND	-	
T15	GND	-		GND	-	
T16	GND	-		GND	-	
T17	GND	-		GND	-	
T18	GND	-		GND	-	
T19	GND	-		GND	-	
T20	GND	-		GND	-	
T21	GND	-		GND	-	
U11	GND	-		GND	-	
U12	GND	-		GND	-	
U13	GND	-		GND	-	
U14	GND	-		GND	-	
U15	GND	-		GND	-	
U16	GND	-		GND	-	
U17	GND	-		GND	-	

LFSC/M25, LFSC/M40 Logic Signal Connections: 1020 fcBGA^{1, 2} (Cont.)

Ball Number	LFSC/M25			LFSC/M40		
	Ball Function	VCCIO Bank	Dual Function	Ball Function	VCCIO Bank	Dual Function
AM21	PB29A	5		PB38A	5	
AM20	PB29B	5		PB38B	5	
AH21	PB29C	5		PB38C	5	
AH20	PB29D	5		PB38D	5	
AJ18	PB31A	5		PB39A	5	
AK18	PB31B	5		PB39B	5	
AH19	PB31C	5		PB39C	5	
AH18	PB31D	5		PB39D	5	
AL19	PB32A	5		PB41A	5	
AM19	PB32B	5		PB41B	5	
AH17	PB32C	5		PB41C	5	
AG17	PB32D	5		PB41D	5	
AL18	PB33A	5		PB42A	5	
AM18	PB33B	5		PB42B	5	
AC17	PB33C	5		PB42C	5	
AD17	PB33D	5		PB42D	5	
AL17	PB35A	5		PB43A	5	
AM17	PB35B	5		PB43B	5	
AE17	PB35C	5		PB43C	5	
AF17	PB35D	5		PB43D	5	
AM16	PB37A	4		PB45A	4	
AL16	PB37B	4		PB45B	4	
AF16	PB37C	4		PB45C	4	
AE16	PB37D	4		PB45D	4	
AM15	PB38A	4		PB46A	4	
AL15	PB38B	4		PB46B	4	
AD16	PB38C	4		PB46C	4	
AC16	PB38D	4		PB46D	4	
AM14	PB39A	4		PB47A	4	
AL14	PB39B	4		PB47B	4	
AG16	PB39C	4		PB47C	4	
AH16	PB39D	4		PB47D	4	
AK15	PB41A	4		PB49A	4	
AJ15	PB41B	4		PB49B	4	
AH15	PB41C	4		PB49C	4	
AH14	PB41D	4		PB49D	4	
AM13	PB42A	4		PB50A	4	
AM12	PB42B	4		PB50B	4	
AH13	PB42C	4		PB50C	4	
AH12	PB42D	4		PB50D	4	
AK14	PB43A	4		PB51A	4	
AJ14	PB43B	4		PB51B	4	
AE15	PB43C	4		PB51C	4	
AD15	PB43D	4		PB51D	4	
AL13	PB46A	4	PCLKT4_2	PB53A	4	PCLKT4_2
AL12	PB46B	4	PCLKC4_2	PB53B	4	PCLKC4_2
AG14	PB46C	4	PCLKT4_7	PB53C	4	PCLKT4_7
AG13	PB46D	4	PCLKC4_7	PB53D	4	PCLKC4_7
AM11	PB47A	4	PCLKT4_1	PB54A	4	PCLKT4_1
AM10	PB47B	4	PCLKC4_1	PB54B	4	PCLKC4_1

LFSC/M25, LFSC/M40 Logic Signal Connections: 1020 fcBGA^{1, 2} (Cont.)

Ball Number	LFSC/M25			LFSC/M40		
	Ball Function	VCCIO Bank	Dual Function	Ball Function	VCCIO Bank	Dual Function
E22	VCC12	-		VCC12	-	
E21	VCC12	-		VCC12	-	
E3	VCC12	-		VCC12	-	
E4	VCC12	-		VCC12	-	
E6	VCC12	-		VCC12	-	
E7	VCC12	-		VCC12	-	
E8	VCC12	-		VCC12	-	
E9	VCC12	-		VCC12	-	
E11	VCC12	-		VCC12	-	
E12	VCC12	-		VCC12	-	
A23	GND	-		GND	-	
A31	GND	-		GND	-	
AA13	GND	-		GND	-	
AA15	GND	-		GND	-	
AA18	GND	-		GND	-	
AA20	GND	-		GND	-	
AA26	GND	-		GND	-	
AA6	GND	-		GND	-	
AB10	GND	-		GND	-	
AB24	GND	-		GND	-	
AC14	GND	-		GND	-	
AC22	GND	-		GND	-	
AC29	GND	-		GND	-	
AC3	GND	-		GND	-	
AD11	GND	-		GND	-	
AD19	GND	-		GND	-	
AD27	GND	-		GND	-	
AD7	GND	-		GND	-	
AF12	GND	-		GND	-	
AF18	GND	-		GND	-	
AF24	GND	-		GND	-	
AF30	GND	-		GND	-	
AF4	GND	-		GND	-	
AG15	GND	-		GND	-	
AG21	GND	-		GND	-	
AG9	GND	-		GND	-	
AJ10	GND	-		GND	-	
AJ16	GND	-		GND	-	
AJ20	GND	-		GND	-	
AJ26	GND	-		GND	-	
AJ29	GND	-		GND	-	
AJ4	GND	-		GND	-	
AK13	GND	-		GND	-	
AK17	GND	-		GND	-	
AK23	GND	-		GND	-	
AK7	GND	-		GND	-	
AL1	GND	-		GND	-	
AL32	GND	-		GND	-	
AM2	GND	-		GND	-	
AM31	GND	-		GND	-	

LFSC/M25, LFSC/M40 Logic Signal Connections: 1020 fcBGA^{1, 2} (Cont.)

Ball Number	LFSC/M25			LFSC/M40		
	Ball Function	VCCIO Bank	Dual Function	Ball Function	VCCIO Bank	Dual Function
B1	GND	-		GND	-	
B32	GND	-		GND	-	
C11	GND	-		GND	-	
C12	GND	-		GND	-	
C16	GND	-		GND	-	
C21	GND	-		GND	-	
C22	GND	-		GND	-	
C24	GND	-		GND	-	
C25	GND	-		GND	-	
C26	GND	-		GND	-	
C27	GND	-		GND	-	
C29	GND	-		GND	-	
C3	GND	-		GND	-	
C30	GND	-		GND	-	
C4	GND	-		GND	-	
C6	GND	-		GND	-	
C7	GND	-		GND	-	
C8	GND	-		GND	-	
C9	GND	-		GND	-	
D17	GND	-		GND	-	
F18	GND	-		GND	-	
F3	GND	-		GND	-	
F30	GND	-		GND	-	
F9	GND	-		GND	-	
G15	GND	-		GND	-	
G24	GND	-		GND	-	
G29	GND	-		GND	-	
G3	GND	-		GND	-	
J14	GND	-		GND	-	
J22	GND	-		GND	-	
J26	GND	-		GND	-	
J6	GND	-		GND	-	
K11	GND	-		GND	-	
K19	GND	-		GND	-	
K30	GND	-		GND	-	
K4	GND	-		GND	-	
L23	GND	-		GND	-	
L9	GND	-		GND	-	
M13	GND	-		GND	-	
M15	GND	-		GND	-	
M18	GND	-		GND	-	
M20	GND	-		GND	-	
M27	GND	-		GND	-	
M7	GND	-		GND	-	
N12	GND	-		GND	-	
N14	GND	-		GND	-	
N19	GND	-		GND	-	
N21	GND	-		GND	-	
N29	GND	-		GND	-	
N3	GND	-		GND	-	

LFSC/M25, LFSC/M40 Logic Signal Connections: 1020 fcBGA^{1, 2} (Cont.)

Ball Number	LFSC/M25			LFSC/M40		
	Ball Function	VCCIO Bank	Dual Function	Ball Function	VCCIO Bank	Dual Function
AA21	VCCAUX	-		VCCAUX	-	
AA22	VCCAUX	-		VCCAUX	-	
AB11	VCCAUX	-		VCCAUX	-	
AB12	VCCAUX	-		VCCAUX	-	
AB15	VCCAUX	-		VCCAUX	-	
AB16	VCCAUX	-		VCCAUX	-	
AB17	VCCAUX	-		VCCAUX	-	
AB18	VCCAUX	-		VCCAUX	-	
AB21	VCCAUX	-		VCCAUX	-	
AB22	VCCAUX	-		VCCAUX	-	
L11	VCCAUX	-		VCCAUX	-	
L12	VCCAUX	-		VCCAUX	-	
L14	VCCAUX	-		VCCAUX	-	
L15	VCCAUX	-		VCCAUX	-	
L18	VCCAUX	-		VCCAUX	-	
L19	VCCAUX	-		VCCAUX	-	
L21	VCCAUX	-		VCCAUX	-	
L22	VCCAUX	-		VCCAUX	-	
M11	VCCAUX	-		VCCAUX	-	
M12	VCCAUX	-		VCCAUX	-	
M21	VCCAUX	-		VCCAUX	-	
M22	VCCAUX	-		VCCAUX	-	
P11	VCCAUX	-		VCCAUX	-	
P22	VCCAUX	-		VCCAUX	-	
R11	VCCAUX	-		VCCAUX	-	
R22	VCCAUX	-		VCCAUX	-	
V11	VCCAUX	-		VCCAUX	-	
V22	VCCAUX	-		VCCAUX	-	
W11	VCCAUX	-		VCCAUX	-	
W22	VCCAUX	-		VCCAUX	-	
N11	VTT_2	2		VTT_2	2	
R10	VTT_2	2		VTT_2	2	
T11	VTT_3	3		VTT_3	3	
U11	VTT_3	3		VTT_3	3	
Y11	VTT_3	3		VTT_3	3	
AB13	VTT_4	4		VTT_4	4	
AB14	VTT_4	4		VTT_4	4	
AC15	VTT_4	4		VTT_4	4	
AB19	VTT_5	5		VTT_5	5	
AB20	VTT_5	5		VTT_5	5	
AC18	VTT_5	5		VTT_5	5	
T22	VTT_6	6		VTT_6	6	
U22	VTT_6	6		VTT_6	6	
Y22	VTT_6	6		VTT_6	6	
N22	VTT_7	7		VTT_7	7	
R23	VTT_7	7		VTT_7	7	
M17	VCC12	-		VCC12	-	
M16	VCC12	-		VCC12	-	
T12	VCC12	-		VCC12	-	
T21	VCC12	-		VCC12	-	

LFSC/M40, LFSC/M80 Logic Signal Connections: 1152 fcBGA^{1, 2} (Cont.)

Ball Number	LFSC/M40			LFSC/M80		
	Ball Function	VCCIO Bank	Dual Function	Ball Function	VCCIO Bank	Dual Function
AG18	PB42C	5		PB61C	5	
AF18	PB42D	5		PB61D	5	
AP19	PB43A	5		PB63A	5	
AP18	PB43B	5		PB63B	5	
AJ18	PB43C	5		PB63C	5	
AH18	PB43D	5		PB63D	5	
AP17	PB45A	4		PB65A	4	
AP16	PB45B	4		PB65B	4	
AJ17	PB45C	4		PB65C	4	
AH17	PB45D	4		PB65D	4	
AN17	PB46A	4		PB66A	4	
AN16	PB46B	4		PB66B	4	
AE17	PB46C	4		PB66C	4	
AD17	PB46D	4		PB66D	4	
AK17	PB47A	4		PB67A	4	
AK16	PB47B	4		PB67B	4	
AG17	PB47C	4		PB67C	4	
AF17	PB47D	4		PB67D	4	
AM16	PB49A	4		PB69A	4	
AM15	PB49B	4		PB69B	4	
AJ15	PB49C	4		PB69C	4	
AJ14	PB49D	4		PB69D	4	
AL16	PB50A	4		PB70A	4	
AL15	PB50B	4		PB70B	4	
AG16	PB50C	4		PB70C	4	
AF16	PB50D	4		PB70D	4	
AP15	PB51A	4		PB71A	4	
AP14	PB51B	4		PB71B	4	
AH15	PB51C	4		PB71C	4	
AH14	PB51D	4		PB71D	4	
AN15	PB53A	4	PCLKT4_2	PB74A	4	PCLKT4_2
AN14	PB53B	4	PCLKC4_2	PB74B	4	PCLKC4_2
AE16	PB53C	4	PCLKT4_7	PB74C	4	PCLKT4_7
AD16	PB53D	4	PCLKC4_7	PB74D	4	PCLKC4_7
AK15	PB54A	4	PCLKT4_1	PB75A	4	PCLKT4_1
AK14	PB54B	4	PCLKC4_1	PB75B	4	PCLKC4_1
AG15	PB54C	4	PCLKT4_6	PB75C	4	PCLKT4_6
AG14	PB54D	4	PCLKC4_6	PB75D	4	PCLKC4_6
AM13	PB55A	4	PCLKT4_0	PB77A	4	PCLKT4_0
AM12	PB55B	4	PCLKC4_0	PB77B	4	PCLKC4_0
AJ12	PB55C	4	VREF2_4	PB77C	4	VREF2_4
AJ11	PB55D	4		PB77D	4	
AL13	PB57A	4	PCLKT4_5	PB79A	4	PCLKT4_5
AL12	PB57B	4	PCLKC4_5	PB79B	4	PCLKC4_5
AH12	PB57C	4		PB79C	4	

LFSC/M40, LFSC/M80 Logic Signal Connections: 1152 fcBGA^{1, 2} (Cont.)

Ball Number	LFSC/M40			LFSC/M80		
	Ball Function	VCCIO Bank	Dual Function	Ball Function	VCCIO Bank	Dual Function
E24	B_HDINP1_L	-	PCS 361 CH 1 IN P	B_HDINP1_L	-	PCS 361 CH 1 IN P
F24	B_HDINN1_L	-	PCS 361 CH 1 IN N	B_HDINN1_L	-	PCS 361 CH 1 IN N
A23	B_HDOUTP1_L	-	PCS 361 CH 1 OUT P	B_HDOUTP1_L	-	PCS 361 CH 1 OUT P
L25	VCC12	-		VCC12	-	
B23	B_HDOUTN1_L	-	PCS 361 CH 1 OUT N	B_HDOUTN1_L	-	PCS 361 CH 1 OUT N
D24	B_VDDOB1_L	-		B_VDDOB1_L	-	
B24	B_HDOUTN0_L	-	PCS 361 CH 0 OUT N	B_HDOUTN0_L	-	PCS 361 CH 0 OUT N
D25	B_VDDOB0_L	-		B_VDDOB0_L	-	
A24	B_HDOUTP0_L	-	PCS 361 CH 0 OUT P	B_HDOUTP0_L	-	PCS 361 CH 0 OUT P
K25	VCC12	-		VCC12	-	
F25	B_HDINN0_L	-	PCS 361 CH 0 IN N	B_HDINN0_L	-	PCS 361 CH 0 IN N
E25	B_HDINP0_L	-	PCS 361 CH 0 IN P	B_HDINP0_L	-	PCS 361 CH 0 IN P
D28	B_VDDIB0_L	-		B_VDDIB0_L	-	
G25	VCC12	-		VCC12	-	
D29	A_VDDIB3_L	-		A_VDDIB3_L	-	
C25	VCC12	-		VCC12	-	
A25	A_HDINP3_L	-	PCS 360 CH 3 IN P	A_HDINP3_L	-	PCS 360 CH 3 IN P
B25	A_HDINN3_L	-	PCS 360 CH 3 IN N	A_HDINN3_L	-	PCS 360 CH 3 IN N
A26	A_HDOUTP3_L	-	PCS 360 CH 3 OUT P	A_HDOUTP3_L	-	PCS 360 CH 3 OUT P
E27	VCC12	-		VCC12	-	
B26	A_HDOUTN3_L	-	PCS 360 CH 3 OUT N	A_HDOUTN3_L	-	PCS 360 CH 3 OUT N
F26	A_VDDOB3_L	-		A_VDDOB3_L	-	
B27	A_HDOUTN2_L	-	PCS 360 CH 2 OUT N	A_HDOUTN2_L	-	PCS 360 CH 2 OUT N
F27	A_VDDOB2_L	-		A_VDDOB2_L	-	
A27	A_HDOUTP2_L	-	PCS 360 CH 2 OUT P	A_HDOUTP2_L	-	PCS 360 CH 2 OUT P
E28	VCC12	-		VCC12	-	
B28	A_HDINN2_L	-	PCS 360 CH 2 IN N	A_HDINN2_L	-	PCS 360 CH 2 IN N
A28	A_HDINP2_L	-	PCS 360 CH 2 IN P	A_HDINP2_L	-	PCS 360 CH 2 IN P
D30	A_VDDIB2_L	-		A_VDDIB2_L	-	
C28	VCC12	-		VCC12	-	
D31	A_VDDIB1_L	-		A_VDDIB1_L	-	
C29	VCC12	-		VCC12	-	
A29	A_HDINP1_L	-	PCS 360 CH 1 IN P	A_HDINP1_L	-	PCS 360 CH 1 IN P
B29	A_HDINN1_L	-	PCS 360 CH 1 IN N	A_HDINN1_L	-	PCS 360 CH 1 IN N
A30	A_HDOUTP1_L	-	PCS 360 CH 1 OUT P	A_HDOUTP1_L	-	PCS 360 CH 1 OUT P
E29	VCC12	-		VCC12	-	
B30	A_HDOUTN1_L	-	PCS 360 CH 1 OUT N	A_HDOUTN1_L	-	PCS 360 CH 1 OUT N
F28	A_VDDOB1_L	-		A_VDDOB1_L	-	
B31	A_HDOUTN0_L	-	PCS 360 CH 0 OUT N	A_HDOUTN0_L	-	PCS 360 CH 0 OUT N
F29	A_VDDOB0_L	-		A_VDDOB0_L	-	
A31	A_HDOUTP0_L	-	PCS 360 CH 0 OUT P	A_HDOUTP0_L	-	PCS 360 CH 0 OUT P
E30	VCC12	-		VCC12	-	
B32	A_HDINN0_L	-	PCS 360 CH 0 IN N	A_HDINN0_L	-	PCS 360 CH 0 IN N
A32	A_HDINP0_L	-	PCS 360 CH 0 IN P	A_HDINP0_L	-	PCS 360 CH 0 IN P
D32	A_VDDIB0_L	-		A_VDDIB0_L	-	

LFSC/M115 Logic Signal Connections: 1152 fcBGA^{1, 2}

Ball Number	LFSC/M115		
	Ball Function	VCCIO Bank	Dual Function
W30	PL69B	6	VREF1_6
W27	PL69C	6	
Y27	PL69D	6	
T33	PL70A	6	
U33	PL70B	6	
V25	PL70C	6	
W25	PL70D	6	
U34	PL71A	6	
V34	PL71B	6	
V26	PL71C	6	
W26	PL71D	6	
V33	PL74A	6	
W33	PL74B	6	
V24	PL74C	6	
W24	PL74D	6	
W31	PL77A	6	
Y31	PL77B	6	
Y29	PL77C	6	
AA29	PL77D	6	
Y33	PL79A	6	
AA33	PL79B	6	
Y28	PL79C	6	
AA28	PL79D	6	
AB32	PL90A	6	
AC32	PL90B	6	
AA26	PL90C	6	
AA27	PL90D	6	
AB31	PL91A	6	DIFFR_6
AC31	PL91B	6	
Y24	PL91C	6	
AA24	PL91D	6	
AE34	PL92A	6	
AF34	PL92B	6	
AB30	PL92C	6	
AC30	PL92D	6	
AD33	PL94A	6	
AE33	PL94B	6	
AD30	PL94C	6	
AE30	PL94D	6	
AE32	PL96A	6	
AF32	PL96B	6	
AA25	PL96C	6	
AB25	PL96D	6	

LFSC/M115 Logic Signal Connections: 1152 fcBGA^{1, 2}

Ball Number	LFSC/M115		
	Ball Function	VCCIO Bank	Dual Function
AN8	PB123B	4	
AG11	PB123C	4	
AG10	PB123D	4	
AP7	PB125A	4	
AP6	PB125B	4	
AG13	PB125C	4	
AG12	PB125D	4	
AN7	PB127A	4	
AN6	PB127B	4	
AK9	PB127C	4	
AK8	PB127D	4	
AP5	PB129A	4	
AP4	PB129B	4	
AD11	PB129C	4	
AE11	PB129D	4	
AM7	PB131A	4	
AM6	PB131B	4	
AJ9	PB131C	4	
AJ8	PB131D	4	
AP3	PB133A	4	
AN3	PB133B	4	
AF10	PB133C	4	
AE10	PB133D	4	
AL7	PB135A	4	
AL6	PB135B	4	
AK7	PB135C	4	
AK6	PB135D	4	
AN5	PB138A	4	
AN4	PB138B	4	
AH9	PB138C	4	VREF1_4
AH8	PB138D	4	
AM3	PB139A	4	LRC_DLLT_IN_C/LRC_DLLT_FB_D
AM4	PB139B	4	LRC_DLLC_IN_C/LRC_DLLC_FB_D
AG9	PB139C	4	
AG8	PB139D	4	
AN2	PB141A	4	LRC_PLLT_IN_A/LRC_PLLT_FB_B
AM2	PB141B	4	LRC_PLLC_IN_A/LRC_PLLC_FB_B
AJ6	PB141C	4	LRC_DLLT_IN_D/LRC_DLLT_FB_C
AH6	PB141D	4	LRC_DLLC_IN_D/LRC_DLLC_FB_C
AF7	PROBE_VCC	-	
AF8	PROBE_GND	-	
AG7	PR117D	3	LRC_PLLC_IN_B/LRC_PLLC_FB_A
AG6	PR117C	3	LRC_PLLT_IN_B/LRC_PLLT_FB_A

Conventional Packaging**Commercial**

Part Number	Grade	Package	Balls	Temp.	LUTs (K)
LFSC3GA15E-7F256C	-7	fpBGA	256	COM	15.2
LFSC3GA15E-6F256C	-6	fpBGA	256	COM	15.2
LFSC3GA15E-5F256C	-5	fpBGA	256	COM	15.2
LFSC3GA15E-7F900C	-7	fpBGA	900	COM	15.2
LFSC3GA15E-6F900C	-6	fpBGA	900	COM	15.2
LFSC3GA15E-5F900C	-5	fpBGA	900	COM	15.2

Part Number	Grade	Package	Balls	Temp.	LUTs (K)
LFSCM3GA15EP1-7F256C	-7	fpBGA	256	COM	15.2
LFSCM3GA15EP1-6F256C	-6	fpBGA	256	COM	15.2
LFSCM3GA15EP1-5F256C	-5	fpBGA	256	COM	15.2
LFSCM3GA15EP1-7F900C	-7	fpBGA	900	COM	15.2
LFSCM3GA15EP1-6F900C	-6	fpBGA	900	COM	15.2
LFSCM3GA15EP1-5F900C	-5	fpBGA	900	COM	15.2

Part Number	Grade	Package	Balls	Temp.	LUTs (K)
LFSC3GA25E-7F900C	-7	fpBGA	900	COM	25.4
LFSC3GA25E-6F900C	-6	fpBGA	900	COM	25.4
LFSC3GA25E-5F900C	-5	fpBGA	900	COM	25.4
LFSC3GA25E-7FF1020C ¹	-7	Organic fcBGA	1020	COM	25.4
LFSC3GA25E-6FF1020C ¹	-6	Organic fcBGA	1020	COM	25.4
LFSC3GA25E-5FF1020C ¹	-5	Organic fcBGA	1020	COM	25.4
LFSC3GA25E-7FFA1020C	-7	Organic fcBGA Revision 2	1020	COM	25.4
LFSC3GA25E-6FFA1020C	-6	Organic fcBGA Revision 2	1020	COM	25.4
LFSC3GA25E-5FFA1020C	-5	Organic fcBGA Revision 2	1020	COM	25.4

1. Converted to organic flip-chip BGA package revision 2 per [PCN #02A-10](#).

Part Number	Grade	Package	Balls	Temp.	LUTs (K)
LFSCM3GA25EP1-7F900C	-7	fpBGA	900	COM	25.4
LFSCM3GA25EP1-6F900C	-6	fpBGA	900	COM	25.4
LFSCM3GA25EP1-5F900C	-5	fpBGA	900	COM	25.4
LFSCM3GA25EP1-7FF1020C ¹	-7	Organic fcBGA	1020	COM	25.4
LFSCM3GA25EP1-6FF1020C ¹	-6	Organic fcBGA	1020	COM	25.4
LFSCM3GA25EP1-5FF1020C ¹	-5	Organic fcBGA	1020	COM	25.4
LFSCM3GA25EP1-7FFA1020C	-7	Organic fcBGA Revision 2	1020	COM	25.4
LFSCM3GA25EP1-6FFA1020C	-6	Organic fcBGA Revision 2	1020	COM	25.4
LFSCM3GA25EP1-5FFA1020C	-5	Organic fcBGA Revision 2	1020	COM	25.4

1. Converted to organic flip-chip BGA package revision 2 per [PCN #02A-10](#).

Commercial, Cont.

Part Number	Grade	Package	Balls	Temp.	LUTs (K)
LFSC3GA80E-7FC1152C ¹	-7	Ceramic fcBGA	1152	COM	80.1
LFSC3GA80E-6FC1152C ¹	-6	Ceramic fcBGA	1152	COM	80.1
LFSC3GA80E-5FC1152C ¹	-5	Ceramic fcBGA	1152	COM	80.1
LFSC3GA80E-7FF1152C	-7	Organic fcBGA	1152	COM	80.1
LFSC3GA80E-6FF1152C	-6	Organic fcBGA	1152	COM	80.1
LFSC3GA80E-5FF1152C	-5	Organic fcBGA	1152	COM	80.1
LFSC3GA80E-7FC1704C ¹	-7	Ceramic fcBGA	1704	COM	80.1
LFSC3GA80E-6FC1704C ¹	-6	Ceramic fcBGA	1704	COM	80.1
LFSC3GA80E-5FC1704C ¹	-5	Ceramic fcBGA	1704	COM	80.1
LFSC3GA80E-7FF1704C	-7	Organic fcBGA	1704	COM	80.1
LFSC3GA80E-6FF1704C	-6	Organic fcBGA	1704	COM	80.1
LFSC3GA80E-5FF1704C	-5	Organic fcBGA	1704	COM	80.1

1. Converted to organic flip-chip BGA package per [PCN #01A-10](#).

Part Number	Grade	Package	Balls	Temp.	LUTs (K)
LFSCM3GA80EP1-7FC1152C ¹	-7	Ceramic fcBGA	1152	COM	80.1
LFSCM3GA80EP1-6FC1152C ¹	-6	Ceramic fcBGA	1152	COM	80.1
LFSCM3GA80EP1-5FC1152C ¹	-5	Ceramic fcBGA	1152	COM	80.1
LFSCM3GA80EP1-7FF1152C	-7	Organic fcBGA	1152	COM	80.1
LFSCM3GA80EP1-6FF1152C	-6	Organic fcBGA	1152	COM	80.1
LFSCM3GA80EP1-5FF1152C	-5	Organic fcBGA	1152	COM	80.1
LFSCM3GA80EP1-7FC1704C ¹	-7	Ceramic fcBGA	1704	COM	80.1
LFSCM3GA80EP1-6FC1704C ¹	-6	Ceramic fcBGA	1704	COM	80.1
LFSCM3GA80EP1-5FC1704C ¹	-5	Ceramic fcBGA	1704	COM	80.1
LFSCM3GA80EP1-7FF1704C	-7	Organic fcBGA	1704	COM	80.1
LFSCM3GA80EP1-6FF1704C	-6	Organic fcBGA	1704	COM	80.1
LFSCM3GA80EP1-5FF1704C	-5	Organic fcBGA	1704	COM	80.1

1. Converted to organic flip-chip BGA package per [PCN #01A-10](#).

Part Number	Grade	Package	Balls	Temp.	LUTs (K)
LFSC3GA115E-6FC1152C ¹	-6	Ceramic fcBGA	1152	COM	115.2
LFSC3GA115E-5FC1152C ¹	-5	Ceramic fcBGA	1152	COM	115.2
LFSC3GA115E-6FF1152C	-6	Organic fcBGA	1152	COM	115.2
LFSC3GA115E-5FF1152C	-5	Organic fcBGA	1152	COM	115.2
LFSC3GA115E-6FC1704C ¹	-6	Ceramic fcBGA	1704	COM	115.2
LFSC3GA115E-5FC1704C ¹	-5	Ceramic fcBGA	1704	COM	115.2
LFSC3GA115E-6FF1704C	-6	Organic fcBGA	1704	COM	115.2
LFSC3GA115E-5FF1704C	-5	Organic fcBGA	1704	COM	115.2

1. Converted to organic flip-chip BGA package per [PCN #01A-10](#).

Industrial

Part Number	Grade	Package	Balls	Temp.	LUTs (K)
LFSC3GA15E-6F256I	-6	fpBGA	256	IND	15.2
LFSC3GA15E-5F256I	-5	fpBGA	256	IND	15.2
LFSC3GA15E-6F900I	-6	fpBGA	900	IND	15.2
LFSC3GA15E-5F900I	-5	fpBGA	900	IND	15.2

Part Number	Grade	Package	Balls	Temp.	LUTs (K)
LFSCM3GA15EP1-6F256I	-6	fpBGA	256	IND	15.2
LFSCM3GA15EP1-5F256I	-5	fpBGA	256	IND	15.2
LFSCM3GA15EP1-6F900I	-6	fpBGA	900	IND	15.2
LFSCM3GA15EP1-5F900I	-5	fpBGA	900	IND	15.2

Part Number	Grade	Package	Balls	Temp.	LUTs (K)
LFSC3GA25E-6F900I	-6	fpBGA	900	IND	25.4
LFSC3GA25E-5F900I	-5	fpBGA	900	IND	25.4
LFSC3GA25E-6FF1020I ¹	-6	Organic fcBGA	1020	IND	25.4
LFSC3GA25E-5FF1020I ¹	-5	Organic fcBGA	1020	IND	25.4
LFSC3GA25E-6FFA1020I	-6	Organic fcBGA Revision 2	1020	IND	25.4
LFSC3GA25E-5FFA1020I	-5	Organic fcBGA Revision 2	1020	IND	25.4

1. Converted to organic flip-chip BGA package revision 2 per [PCN #02A-10](#).

Part Number	Grade	Package	Balls	Temp.	LUTs (K)
LFSCM3GA25EP1-6F900I	-6	fpBGA	900	IND	25.4
LFSCM3GA25EP1-5F900I	-5	fpBGA	900	IND	25.4
LFSCM3GA25EP1-6FF1020I ¹	-6	Organic fcBGA	1020	IND	25.4
LFSCM3GA25EP1-5FF1020I ¹	-5	Organic fcBGA	1020	IND	25.4
LFSCM3GA25EP1-6FFA1020I	-6	Organic fcBGA Revision 2	1020	IND	25.4
LFSCM3GA25EP1-5FFA1020I	-5	Organic fcBGA Revision 2	1020	IND	25.4

1. Converted to organic flip-chip BGA package revision 2 per [PCN #02A-10](#).

Part Number	Grade	Package	Balls	Temp.	LUTs (K)
LFSC3GA40E-6FF1020I ¹	-6	Organic fcBGA	1020	IND	40.4
LFSC3GA40E-5FF1020I ¹	-5	Organic fcBGA	1020	IND	40.4
LFSC3GA40E-6FFA1020I	-6	Organic fcBGA Revision 2	1020	IND	40.4
LFSC3GA40E-5FFA1020I	-5	Organic fcBGA Revision 2	1020	IND	40.4
LFSC3GA40E-6FC1152I ²	-6	Ceramic fcBGA	1152	IND	40.4
LFSC3GA40E-5FC1152I ²	-5	Ceramic fcBGA	1152	IND	40.4
LFSC3GA40E-6FF1152I	-6	Organic fcBGA	1152	IND	40.4
LFSC3GA40E-5FF1152I	-5	Organic fcBGA	1152	IND	40.4

1. Converted to organic flip-chip BGA package revision 2 per [PCN #02A-10](#).

2. Converted to organic flip-chip BGA package per [PCN #01A-10](#).

For Further Information

For further information about the flexiPCS, see the [LatticeSC/M Family flexiPCS Data Sheet](#).

A variety of technical notes for the LatticeSC/M family are also available on the Lattice Semiconductor website at www.latticesemi.com.

- [LatticeSC PURESPEED I/O Usage Guide](#) (TN1088)
- [LatticeSC PURESPEED I/O Adaptive Input Logic User's Guide](#) (TN1158)
- [LatticeSC sysCLOCK PLL/DLL User's Guide](#) (TN1098)
- [On-Chip Memory Usage Guide for LatticeSC Devices](#) (TN1094)
- [LatticeSC/M DDR/DDR2 SDRAM Memory Interface User's Guide](#) (TN1099)
- [LatticeSC QDRII/II+ SRAM Memory Interface User's Guide](#) (TN1096)
- [LatticeSC sysCONFIG Usage Guide](#) (TN1080)
- [LatticeSC MPI/System Bus](#) (TN1085)
- [SPI Serial Flash Programming Using ispJTAG in LatticeSC Devices](#) (TN1100)
- [Power Estimation and Management for LatticeSC Devices](#) (TN1101)
- [LatticeSC SERDES Jitter](#) (TN1084)
- [LatticeSC FPGAs: Implementing 3.3V Interfaces in 2.5V VCCIO Banks](#) (TN1110)
- [Lattice PCI Express Basic Demo User's Guide](#) (UG08)
- [LatticeSC flexiPCS/SERDES Design Guide](#) (TN1145)
- [Temperature Sensing Diode in LatticeSC Devices](#) (TN1115)
- [SPI4.2 Interoperability Between ORSPI4 and LatticeSC Devices](#) (TN1116)

For further information on Interface standards refer to the following websites:

- JEDEC Standards (LVTTTL, LVCMOS, SSTL, HSTL): www.jedec.org
- Optical Interface (SPI-4.2, XSBI, CSIX and XGMII): www.oiforum.com
- RAPIDIO: www.rapidio.org
- PCI/PCIX: www.pcisig.com